Electronic Acknowledgement Receipt					
EFS ID:	2242845				
Application Number:	10681583				
International Application Number:					
Confirmation Number:	6814				
Title of Invention:	SEMICONDUCTOR MULTI-PACKAGE MODULE HAVING INVERTED SECOND PACKAGE STACKED OVER DIE-UP FLIP-CHIP BALL GRID ARRAY (BGA) PACKAGE				
First Named Inventor/Applicant Name:	Marcos Karnezos				
Customer Number:	22470				
Filer:	Mikio Ishimaru/Meghan Calhoun				
Filer Authorized By:	Mikio Ishimaru				
Attorney Docket Number:	CPAC 1029-5 D3				
Receipt Date:	26-SEP-2007				
Filing Date:	08-OCT-2003				
Time Stamp:	13:08:27				
Application Type:	Utility under 35 USC 111(a)				
Payment information:	1				

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Submitted with Payment	no
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File Listing:

Document Number	Document Description	File Name	File Size(Bytes) /Message Digest	Multi Part /.zip	Pages (if appl.)
1	Power of Attorney	27-409-4CP_ChipPAC_Inc_ signed_POA.pdf	71697 9u95ec00b32db457ab55ad14cf1df9ac9 16d05dc	no	1
Warnings:					

Information:								
2	Assignee showing of ownership per 37 CFR 3.73(b).	27-409-4CP_STATEMENT_ under_3-73b.pdf	66587	no	1			
			1621dc0aa69ad2ef7c11ebd0093534dd 8b92839e					
Warnings:								
Information:								
3 Char	Change of Address	27-409-4CP_Fee_Address_I ndication_Form.pdf	66274	no	1			
	Change of Address		eeef61461604c30:971f3a0632c1c1cdb1c c9fa0b					
Warnings:								
Information:								
	Total Files Size (in bytes): 204558							

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New Applications Under 35 U.S.C. 111

If a new application is being filed and the application includes the necessary components for a filing date (see 37 CFR 1.53(b)-(d) and MPEP 506), a Filing Receipt (37 CFR 1.54) will be issued in due course and the date shown on this Acknowledgement Receipt will establish the filing date of the application.

National Stage of an International Application under 35 U.S.C. 371

If a timely submission to enter the national stage of an international application is compliant with the conditions of 35 U.S.C. 371 and other applicable requirements a Form PCT/DO/EO/903 indicating acceptance of the application as a national stage submission under 35 U.S.C. 371 will be issued in addition to the Filing Receipt, in due course.

New International Application Filed with the USPTO as a Receiving Office

If a new international application is being filed and the international application includes the necessary components for an international filing date (see PCT Article 11 and MPEP 1810), a Notification of the International Application Number and of the International Filing Date (Form PCT/RO/105) will be issued in due course, subject to prescriptions concerning national security, and the date shown on this Acknowledgement Receipt will establish the international filing date of the application.